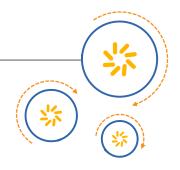


RF360 Europe GmbH

A Qualcomm - TDK Joint Venture



SAW Components

SAW IF filters for base stations

Series/type: B5262

Ordering code: B39181B5262H810

Date: January 07, 2014

Version: 2.0

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Data sheet



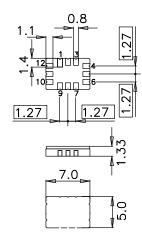
Application

- Low-loss IF filter for base stations
- Usable passband 25 MHz
- Unbalanced or balanced operation possible



Features

- Package size 7.0 x 5.0 x 1.33 mm³
- Package code QCC12E
- RoHS compatible
- Approx. weight 0.25 g
- Ceramic package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Electrostatic Sensitive Device (ESD)
- Filter surface passivated
- Moisture Sensitive Level 1



Pin configuration

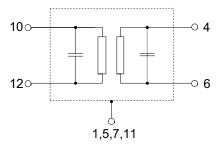
■ 10 Input

■ 12 Input ground or balanced input

■ 4 Output

Output ground or balanced output

1, 5, 7, 11 Case Ground2, 3, 8, 9 To be grounded





Data sheet SMD

Characteristics

Temperature range for specification: $T = -40 \,^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$

Terminating source impedance: $Z_S = 200~\Omega$ balanced and matching network Terminating load impedance: $Z_L = 150~\Omega$ balanced and matching network

					1		
			min.	typ. @ 25 °C	max.		
Nominal frequency		f _N	_	184.32	_	MHz	
Minimum insertion attenuation (including matching network)		α_{min}	_	8.2	9.5	dB	
Passband width	$\alpha_{rel} \leq$ 1.0 dB	B _{1.0 dB}	25	28	_	MHz	
Amplitude ripple (p-p) $f_N \pm 12.50 \; \text{MHz}$ in any segment of 5 MHz in $f_N \pm 12.50 \; \text{MHz}$		Δα	_ _	0.5 0.3	1.0 0.8	dB dB	
Average error vector magnitude ¹⁾		EVM	_	1.8	2.5	%	
Absolute group delay	f _N ± 12.50 MHz	τ	_	0.5	0.55	μs	
Group delay ripple (p-p)	f _N ± 12.50 MHz	Δτ	_	30	50	ns	
Return loss (input / output)			7.5	14.5	_	dB	
75.00 151.82 161.82 201.82 206.82 216.82	e to α _{min}) 75.00 MHz 151.82 MHz 161.82 MHz 166.82 MHz 206.82 MHz 216.82 MHz 290.00 MHz 330.00 MHz	α_{rel}	55 40 30 10 10 30 40 50	65 55 43 32 25 37 50 64	 - - - - - -	dB dB dB dB dB dB	
	410.00 MHz 1000.00 MHz		40 45	60 62	_ _	dB dB	

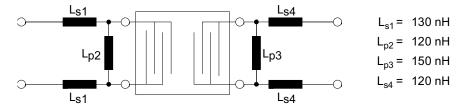
 $^{^{1)}}$ EVM calculation based on root raised cosine filtered QPSK signal (fc_RRC within 174.32 ... 194.32 MHz, bw_RRC= 3.84 MHz)



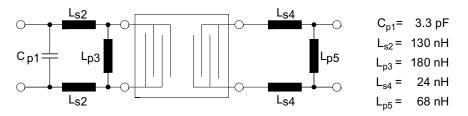
Data sheet



Matching network to 200 $\Omega\,$ balanced input and 150 Ω balanced output



Alternative matching network to 200 $\Omega\,$ balanced input and 150 Ω balanced output



Element values depend upon board layout and properties.

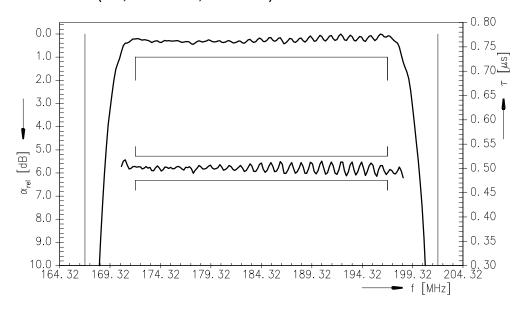
Maximum ratings

Operable temperature range	Т	-40/+85	°C
, ,			
Storage temperature range	T_{stg}	-4 0/+85	°C
DC voltage	V_{DC}	0	V
Input power	P_{IN}		
171.82 196.82 MHz		10	dBm

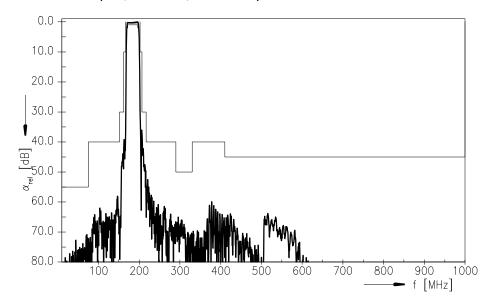




Transfer function (S21, narrowband, normalized)



Transfer function (S21, wideband, normalized)





SAW Components		B5262
SAW IF filter	18	34.32 MHz
Data sheet	SMD	

References

Туре	B5262	
Ordering code	B39181B5262H810	
Marking and package	C61157-Z7-A103	
Packaging	F61074-V8170-Z000	
Date codes	L_1126	
S-parameters	B5262_UN_NB.s4p, B5262_UN_WB.s4p, B5262_NB.s4p, B5262_WB.s4p see file header for port/pin assignment table	
Soldering profile	S_6001	
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.	
Matching coils	See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm	

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